

TLP191B

Telecommunication
 Programmable Controllers
 MOS Gate Driver
 MOS FET Gate Driver

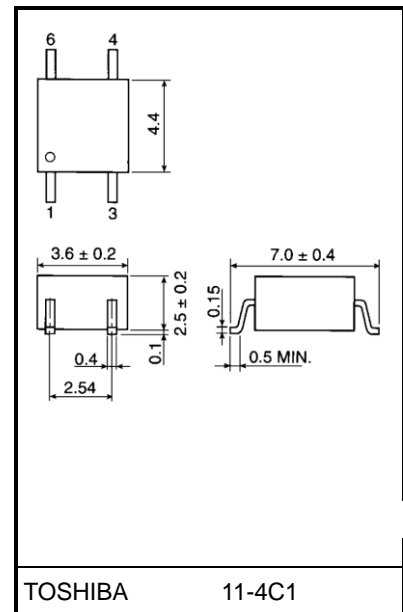
The TOSHIBA mini-flat coupler TLP191B is a small outline coupler, suitable for surface mount assembly.

The TLP191B consists of an infrared emitting diode, optically coupled to a series connected photo diode array with shunt resistor which is suitable for MOS FET gate drive.

TLP191B : Mini Flat Package, 4Pin, one circuit

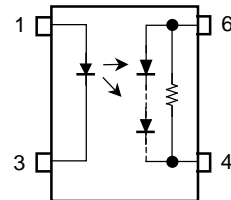
- Open voltage: 7.0 V (min)
- Short current: 24 μ A (min)
- Isolation voltage: 2500 Vrms (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A
 File No.E67349

Unit: mm



Weight: 0.09 g (typ.)

Pin Configuration (top view)



- 1 . Anode
- 3 . Cathode
- 4 . Cathode
- 6 . Anode

Start of commercial production
 1990-11

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
LED	Forward current	I_F	50	mA
	Forward current derating (Ta ≥ 25°C)	$\Delta I_F / ^\circ\text{C}$	-0.5	mA/°C
	Pulse forward current (100 μs pulse, 100 pps)	I_{FP}	1	A
	Reverse voltage	V_R	3	V
	Diode power dissipation	P_D	100	mW
	Diode power dissipation derating (Ta >25°C)	$\Delta P_D / ^\circ\text{C}$	-1.0	mW/°C
	Junction temperature	T_j	125	°C
Detector	Forward current	I_{FD}	50	μA
	Reverse voltage	V_{RD}	10	V
	Output power dissipation	P_O	0.5	mW
	Junction temperature	T_j	125	°C
Storage temperature range		T_{stg}	-55 to 125	°C
Operating temperature range		T_{opr}	-40 to 85	°C
Lead soldering temperature (10 s)		T_{sol}	260	°C
Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)		BV_S	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: Device considered a two terminal device: Pins 1 and 3 shorted together and pins 4 and 6 shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Typ.	Max	Unit
Forward current	I_F	—	20	25	mA
Operating temperature	T_{opr}	-25	—	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V_F	$I_F = 10 \text{ mA}$	1.2	1.4	1.7	V
	Reverse current	I_R	$V_R = 3 \text{ V}$	—	—	10	μA
	Capacitance between terminals	C_T	$V = 0 \text{ V}, f = 1 \text{ MHz}$	—	30	60	pF
Detector	Forward voltage	V_{FD}	$I_{FD} = 10 \mu\text{A}$	—	7	—	V
	Reverse current	I_{RD}	$V_{RD} = 10 \text{ V}$	—	7	—	μA

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Open voltage	V_{OC}	$I_F = 20 \text{ mA}$	7	8	—	V
Short current	I_{SC}	$I_F = 20 \text{ mA}$	24	40	—	μA

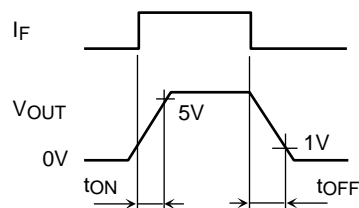
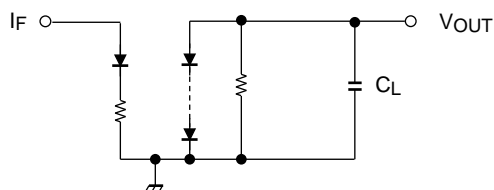
Isolation Characteristics (Ta = 25°C)

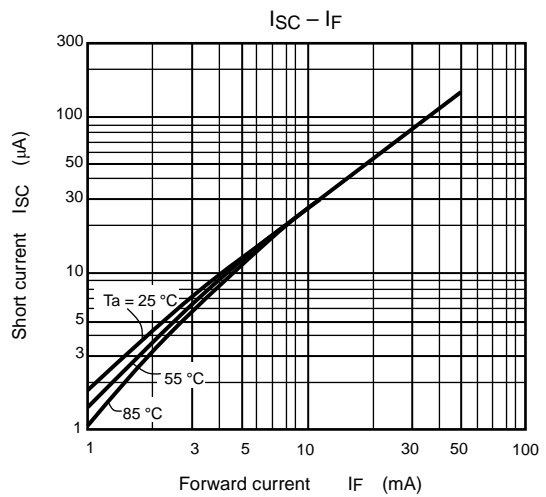
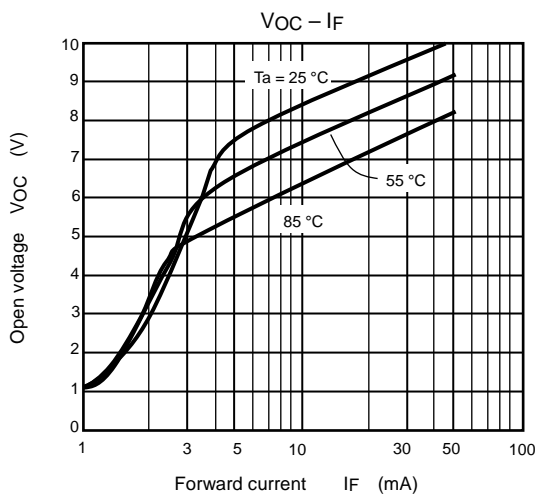
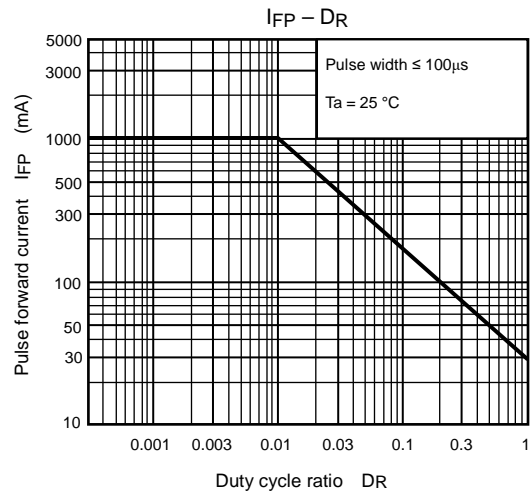
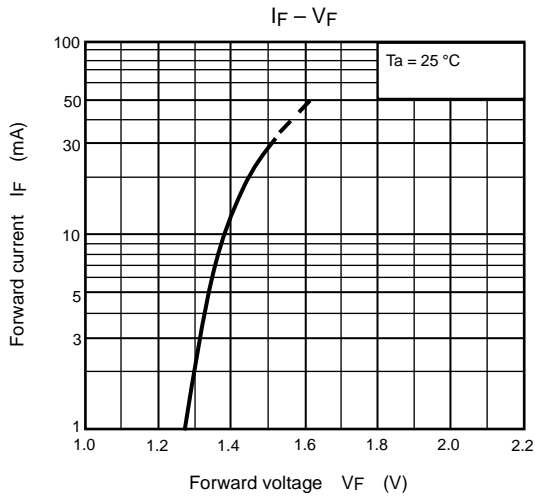
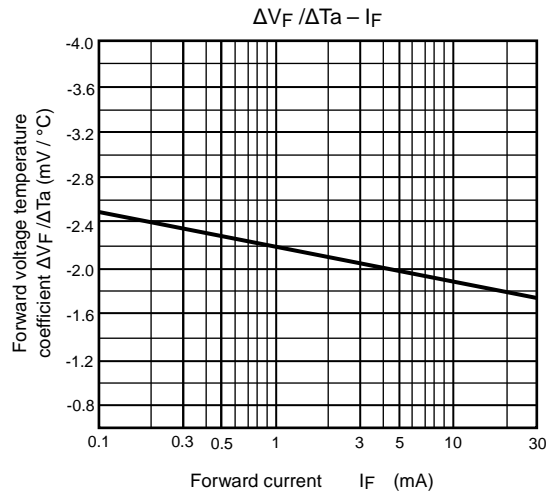
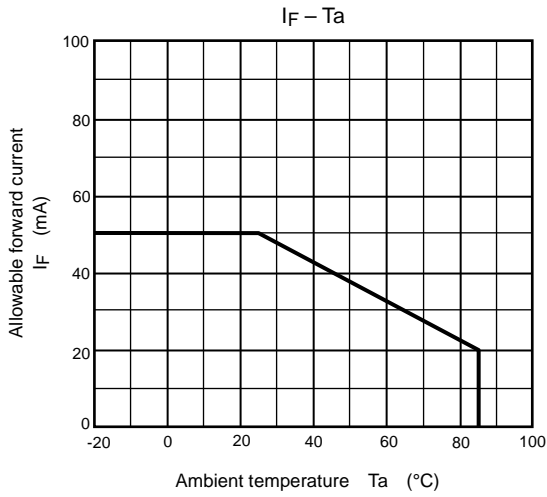
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance input to output	C_S	$V_S = 0 \text{ V}, f = 1 \text{ MHz}$	—	0.8	—	pF
Isolation resistance	R_S	$V_S = 500 \text{ V}, \text{R.H.} \leq 60 \%$	5×10^{10}	10^{14}	—	Ω
Isolation voltage	BV_S	AC, 60 s	2500	—	—	Vrms

Switching Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Turn-on time	t_{ON}	$I_F = 20 \text{ mA}, C_L = 1000 \text{ pF}$ (Note1)	—	0.2	—	ms
Turn-off time	t_{OFF}		—	3	—	

Note 1: Switching time test circuit





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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